

# Fixed Frequency Flyback Controller with Ultra-low No Load Power Consumption

The Future of Analog IC Technology

# DESCRIPTION

HFC0500 is a fixed-frequency current-mode controller with internal slope compensation. It is specifically designed for the medium-power, offline, flyback, switch-mode power supplies. HFC0500 is a green-mode highly efficient controller. At light loads, the controller freezes the peak current and reduces its switching frequency down to 25kHz to offer excellent light-load efficiency. At very light loads, the controller enters burst mode to achieve very low standby power consumption.

HFC0500 offers frequency jittering to help dissipate energy generated by conducted noise.

HFC0500 employs overpower compensation function to narrow the difference of over power protection point between low line and high line.

HFC0500 also has X-cap discharge function to discharge the X-cap when the input is unplugged. This aids in lowering no load power.

HFC0500 features multiple protections that include thermal shutdown (TSD), VCC undervoltage lockout (UVLO), overload protection (OLP), over-voltage protection (OVP), and brown-out protection.

HFC0500 is available in an SOIC8-7A package.

# **FEATURES**

- Fixed-frequency current-mode control with internal slope compensation
- Frequency foldback down to 25kHz at light loads
- Burst mode for low standby power consumption, meeting EuP Lot 6
- Frequency jitter to reduce EMI signature
- X-cap discharge function
- Adjustable overpower compensation
- Internal high-voltage current source
- VCC under-voltage lockout with hysteresis (UVLO)
- Brown-out protection on HV
- Overload protection with programmable delay
- Thermal shutdown (auto-restart with hysteresis)
- Latch-off for external over-voltage protection (OVP) and over-temperature protection (OTP) on TIMER
- Latch-off for Vcc over voltage protection
- Short-circuit protection
- Programmable soft start

## APPLICATIONS

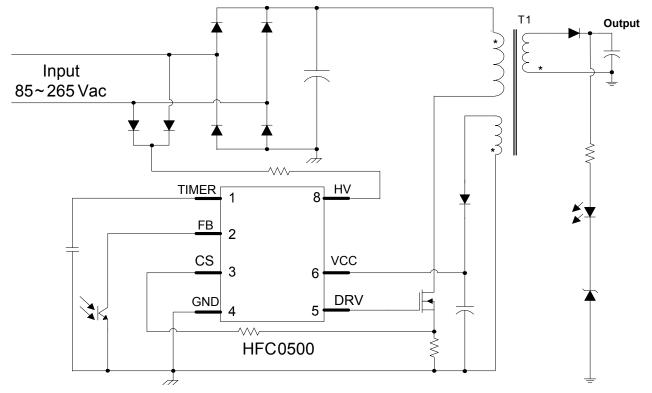
- AC/DC power for small and large appliances
- AC/DC adapters for notebook computers, tablets, and smart phones
- Offline battery chargers
- LCD TVs and monitors

All MPS parts are lead-free, halogen free, and adhere to the RoHS directive. For MPS green status, please visit MPS website under Quality Assurance.

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# **TYPICAL APPLICATION**

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# ORDERING INFORMATION

Part Number*	Package	Top Marking
HFC0500GS	SOIC8-7A	See Below

\* For Tape & Reel, add suffix -Z (e.g. HFC0500GS-Z);

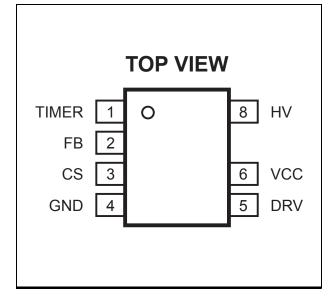
## **TOP MARKING**

HFC0500 LLLLLLL

MPSYWW

HFC0500: first seven digits of the part number; LLLLLLL: lot number; MPS: MPS prefix: Y: year code; WW: week code:

## PACKAGE REFERENCE



## ABSOLUTE MAXIMUM RATINGS (1)

HV	0.7V to 700V
V <sub>CC</sub> , DRV to GND	0.3V to 30V
FB, TIMER, CS to GND	0.3V to 7V
Continuous Power Dissipation (7	Γ <sub>A</sub> = +25°C) <sup>(2)</sup>
	1.3W
Junction Temperature	150°C
Lead Temperature	260°C
Storage Temperature	60°C to +150°C
ESD Capability Human Body M	Iodel (except HV
and DRV)	4.0kV
ESD Capability Human Body Mo	del (DRV) 3.5kV
ESD Capability Human Body Mo	del (HV) 1.8kV
ESD capability for Machine Mod	e400V

## **Recommended Operation Conditions** <sup>(3)</sup>

Operating Junction Temp (T <sub>J</sub> )40°C to +125°C	2
Operating V <sub>cc</sub> range 9V to 24	/

# Thermal Resistance $^{(4)}$ $\theta_{JA}$ $\theta_{JC}$

SOIC8-7A ......96 ...... 45... °C/W

Notes:

- 1) Exceeding these ratings may damage the device.
- 2) The maximum allowable power dissipation is a function of the maximum junction temperature T<sub>J</sub> (MAX), the junction-toambient thermal resistance  $\theta_{JA}$ , and the ambient temperature T<sub>A</sub>. The maximum allowable continuous power dissipation at any ambient temperature is calculated by P<sub>D</sub> (MAX) = (T<sub>J</sub> (MAX)-T<sub>A</sub>)/ $\theta_{JA}$ . Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- The device is not guaranteed to function outside of its operating conditions.
- 4) Measured on JESD51-7, 4-layer PCB.

# **ELECTRICAL CHARACTERICS**

 $V_{cc}\text{=}18V,~T_{J}\text{=}-40^{\circ}\text{C}$  ~ 125°C, Min & Max are guaranteed by characterization, typical is tested under 25°C, unless otherwise specified.

Parameter	Symbol	Conditions	Min	Тур	Max	Unit		
Start-up Current Source (HV)								
Supply Current from LIV	Iнv_400	V <sub>CC</sub> = 12V, V <sub>HV</sub> =400V	1.5	2.8	5	~^^		
Supply Current from HV	I <sub>HV_120</sub>	V <sub>CC</sub> = 12V, V <sub>HV</sub> =120V	1.5	2.7	5	mA		
	Ilk_400	$V_{CC}$ increases to 18V then decreases to 14V, $V_{HV}$ =400V	1	16	25	μΑ		
Leakage Current from HV	Ilk_200	$V_{CC}$ increases to 18V then decreases to 14V, $V_{HV}$ =200V	1	13	22	μΑ		
Break Down Voltage	$V_{BR}$	T <sub>J</sub> = 25°C	700	790		V		
Supply Voltage Management (Vcc)								
VCC Increasing Level at which the Current Source Turns-Off	VCCOFF		12.5	15.5	18	V		
VCC Decreasing Level above which Soft Start Takes Place if HV>HV <sub>ON</sub>	VCCss		10.5	12	13	V		
VCC Hysteresis for Brown-in Detection	VCC <sub>OFF</sub> - VCC <sub>SS</sub>		1.35	3.5		V		
VCC Decreasing Level at which the Current Source Turns-On	VCC <sub>ON</sub>		7.3	8.5	9.6	V		
VCC UVLO Hysteresis	VCC <sub>OFF</sub> - VCC <sub>ON</sub>		5	7		V		
VCC Re-charge Level when Protection Takes Place	VCC <sub>PRO</sub>		4.9	5.5	6.2	V		
VCC Decreasing Level at which the Latch off Phase Ends	VCCLATCH			2.5		V		
Internal IC Consumption	Icc	$V_{FB}=2V, C_L=1nF, V_{CC}=12V$	1.1	1.8	2.7	mA		
Internal IC Consumption, Latch off Phase	Icclatch	V <sub>CC</sub> =VCC <sub>OFF</sub> -1V, TJ=25℃	520	700	880	μA		
Voltage on the VCC above which the Controller Latches off (OVP)	V <sub>OVP</sub>		24	26.5	28.5	V		
Blanking Duration on the OVP Comparator	Tovp			60		μs		

## ELECTRICAL CHARACTERICS (continued)

V<sub>cc</sub>=18V, T<sub>J</sub>=-40°C ~125°C, Min & Max are guaranteed by characterization, typical is tested under 25℃, unless otherwise specified.

Parameter	Symbol	Conditions	Min	Тур	Max	Unit			
Brown-out									
HV Turn on Threshold Voltage $HV_{ON} = \begin{array}{c} V_{HV} & goir \\ up,T_J=25^{\circ}C \end{array}$		5 5	95	107	119	V			
HV Turn off Threshold Voltage	HVOFF	$V_{HV}$ going down, $T_J=25^{\circ}C$	86	97	110	V			
Brown-out Hysteresis	ΔHV	<b>T</b> J <b>=25</b> ℃	7.5	10	12.5	V			
Timer Duration for Line Cycle Drop-out	T <sub>HV</sub>	C <sub>TIMER</sub> =47nF	40			ms			
Oscillator									
Oscillator Frequency	fosc	V <sub>FB</sub> >1.85V,TJ=25℃	62	65	68	kHz			
Frequency Jittering Amplitude, in Percentage of f <sub>OSC</sub>	Ajitter	V <sub>FB</sub> >1.85V,TJ <b>=</b> 25℃	±5	±6.5	±8.3	%			
Frequency jittering entry level	V <sub>FB_JITTER</sub>				1.95	V			
Frequency Jittering Modulation Period	Tjitter	C <sub>TIMER</sub> =47nF		3.7		ms			
Current Sense									
Current Limit Point	VILIM		0.93	1	1.07	V			
Short Circuit Protection Point	VSCP		1.3	1.47	1.63	V			
Current limitation when frequency foldback	$V_{\text{FOLD}}$	V <sub>FB</sub> =1.85V	0.63	0.68	0.73	V			
Current limitation when entry Burst	VIBURL	V <sub>FB</sub> =0.7V		0.11		V			
Current limitation when leave Burst	VIBURH	V <sub>FB</sub> =0.8V		0.15		V			
Leading Edge Blanking for $V_{I \sqcup I M}$	T <sub>LEB1</sub>			350		ns			
Leading Edge Blanking for $V_{\mbox{\scriptsize SCP}}$	$T_{LEB2}$			270		ns			
Slope of the Compensation Ramp	SRAMP		18	25	32	mV/µs			
Feedback (FB )									
Internal Pull-up Resistor	$R_{FB}$		11.5	14	16.5	kΩ			
Internal Pull-up Voltage	Vdd			4.3		V			
$V_{\mbox{\scriptsize FB}}$ to Internal Current Setpoint Division Ratio	K <sub>FB1</sub>	K <sub>FB1</sub> V <sub>FB</sub> =2V		2.8	3.05				
$V_{\mbox{\scriptsize FB}}$ to Internal Current Setpoint Division Ratio	K <sub>FB2</sub>	V <sub>FB</sub> =3V	2.8	3.1	3.4				
FB Decreasing Level at which the Controller Enters the Burst Mode	VBURL	BURL		0.7	0.77	V			
FB Increasing Level at which the Controller Leaves the Burst Mode	VBURH		0.72	0.8	0.88	V			

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## ELECTRICAL CHARACTERICS (continued)

## V<sub>cc</sub>=18V, T<sub>J</sub>=-40°C ~125°C, Min & Max are guaranteed by characterization, typical is tested under 25℃, unless otherwise specified.

Parameter	Symbol	Conditions	Min	Тур	Мах	Unit			
Over Load Protection									
FB Level at which the Controller Enters the OLP after a Dedicated time	Volp	Volp		3.7		V			
Time Duration before OLP when FB Reaches Protection Point	T <sub>OLP</sub>	C <sub>TIMER</sub> =47nF	40			ms			
Over Power Compensation									
V <sub>HV</sub> to I <sub>OPC</sub> Ratio	KOPC			0.45		µA/V			
		V <sub>HV</sub> =120V,V <sub>FB</sub> =2.5V		0					
		V <sub>HV</sub> =155V,V <sub>FB</sub> =2.5V		13					
Current out of CS	Іорс	V <sub>HV</sub> =310V,V <sub>FB</sub> =2.5V		85		μA			
		V <sub>HV</sub> =380V,V <sub>FB</sub> =2.5V , TJ=25℃	90	119	148				
FB Voltage below which Compensation is Removed	Vopc(off)		0.55			V			
FB Voltage above which Compensation is Applied Fully	Vopc(on)				2.2	V			
Frequency Foldback									
FB Voltage Threshold below which Frequency Foldback Starts	VFB(FOLD)			1.8		V			
Minimum Switching Frequency	F <sub>OSC(min)</sub>	T <b>J=25</b> ℃	21	25	30	kHz			
FB Voltage Threshold below which Frequency Foldback Ends	$V_{FB(FOLDE)}$			1.0		V			
Latch-off Input(Integration in TIMER)	•								
The Threshold below which Controller is Latched	VTIMER(LATC H)		0.7	1	1.3	V			
Blanking Duration on Latch Detection	TLATCH			12		μs			

## ELECTRICAL CHARACTERICS (continued)

V<sub>cc</sub>=18V, T<sub>J</sub>=-40°C~125°C, Min & Max are guaranteed by characterization, typical is tested under 25℃, unless otherwise specified.

Parameter	Symbol Conditions		Min	Тур	Мах	Unit		
DRV Voltage								
Driver Voltage High Level	V <sub>High</sub>	C∟=1nF,V <sub>CC</sub> =12V		10.3		V		
Driver Voltage Clamp Level	V <sub>Clamp</sub>	$C_L=1nF,V_{CC}=24V$		13.4		V		
Driver Voltage Low Level	VLow	C∟=1nF,V <sub>CC</sub> =24V		16		mV		
Driver Voltage Rise Time	T <sub>R</sub>	C∟=1nF,V <sub>CC</sub> =16V		13		ns		
Driver Voltage Fall Time	T <sub>F</sub>	$C_L=1nF,V_{CC}=16V$		23		ns		
Driver Pull-up Resistance	R <sub>Pull-up</sub>	C∟=1nF,V <sub>CC</sub> =16V		8		Ω		
Driver Pull-down Resistance	R <sub>Pull-down</sub>	C∟=1nF,V <sub>CC</sub> =16V		10		Ω		
Thermal Shutdown	Thermal Shutdown							
Thermal Shutdown Threshold <sup>(5)</sup>				150		°C		
Thermal Shutdown Hysteresis <sup>(5)</sup>				25		°C		

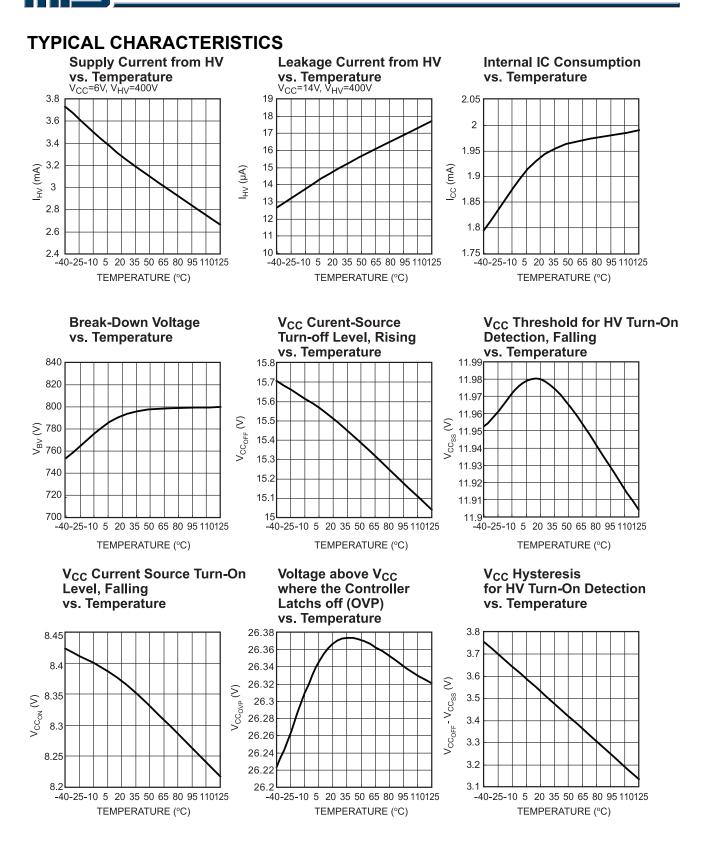
Notes:

5) This parameter is guaranteed by design.

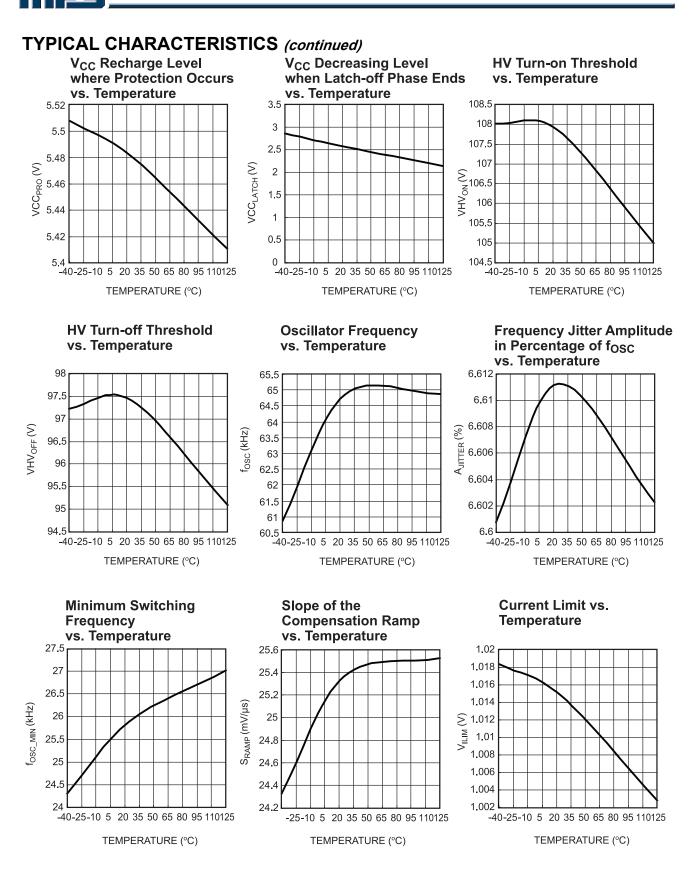
# **PIN FUNCTIONS**

Pin #	Name	Description
1	TIMER	Timer. This pin combines the soft start, frequency jittering, along with the timer functions for OLP, brown-out protection, and X-cap discharge. The IC can be latched off by pulling this pin low.
2	FB	Feedback. Use a pull-down opto-coupler to control output regulation.
3	CS	Current Sense. Senses the primary side current for current-mode operation, and provides a means for over power compensation adjustment.
4	GND	IC Ground.
5	DRV	Drive Signal Output.
6	VCC	Power Supply.
8	HV	High-Voltage Current Source. Includes brown-out and X-cap discharge functions.

HFC0500 - FIXED-FREQUENCY FLYBACK CONTROLLER WITH ULTRA-LOW NO LOAD POWER CONSUMPTION

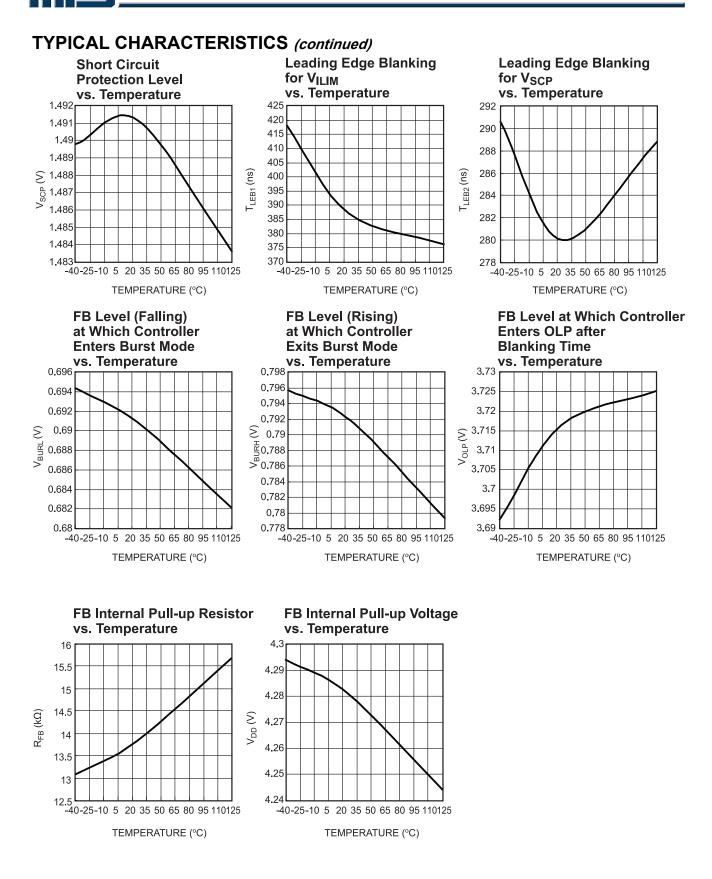


HFC0500 - FIXED-FREQUENCY FLYBACK CONTROLLER WITH ULTRA-LOW NO LOAD POWER CONSUMPTION



HFC0500 Rev. 1.1 5/10/2019

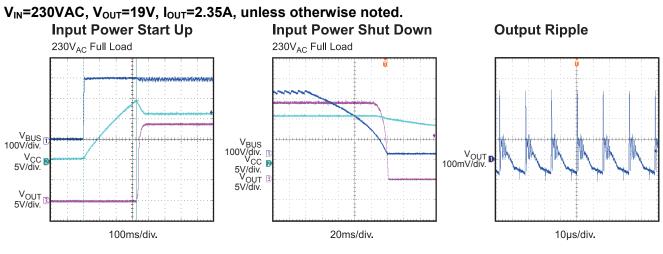
FIC0500 - FIXED-FREQUENCY FLYBACK CONTROLLER WITH ULTRA-LOW NO LOAD POWER CONSUMPTION



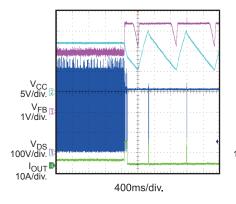
HFC0500 Rev. 1.1 5/10/2019

F HFC0500 - FIXED-FREQUENCY FLYBACK CONTROLLER WITH ULTRA-LOW NO LOAD POWER CONSUMPTION

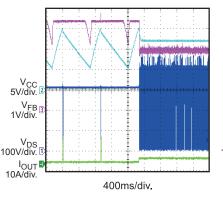
# **TYPICAL PERFORMANCE CHARACTERISIC**



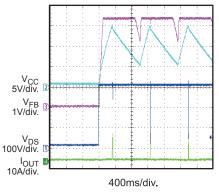
**SCP Entery** 



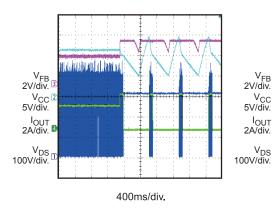
**SCP Rescovery** 



**SCP Power On** 



**OLP Entry** 



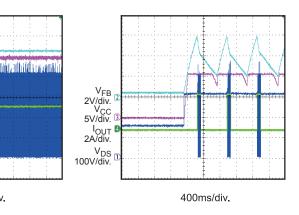
## **OLP Rescovery**

V<sub>FB</sub> 2V/div.

V<sub>CC</sub> 5V/div.

I<sub>OUT</sub> 2A/div.





HFC0500 Rev. 1.1 5/10/2019

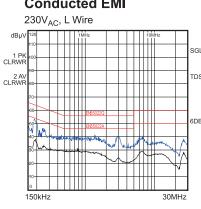
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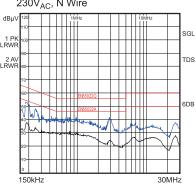
400ms/div.

1 PC

#### **TYPICAL PERFORMANCE CHARACTERISIC** (continued) V<sub>IN</sub>=230VAC, V<sub>OUT</sub>=19V, I<sub>OUT</sub>=2.35A, T<sub>A</sub>=25°C, unless otherwise noted. OVP OTP OVP No Load Full Load No Load V<sub>DS</sub> 200V/div. V<sub>DS</sub> 200V/div. فيربعه والألجيا الداوية V<sub>FB</sub> 1V/div. V<sub>CC</sub> 10V/div. V<sub>CC</sub> 10V/div. V<sub>FB</sub> 1V/div. V<sub>FB</sub> 1V/div. V<sub>CC</sub> 5V/div. V<sub>DS</sub> | 100V/div. V<sub>OUT</sub> 10V/div. V<sub>OUT</sub> 10V/div. 200ms/div. 200ms/div. 2s/div. **Brown-In Brown-Out** X-Cap Discharge 265V<sub>AC</sub>, Full Load V<sub>FB</sub> 2V/div. V<sub>CC</sub> 5V/div. V<sub>FB</sub> 2V/div. V<sub>CC</sub> 5V/div. V<sub>IN</sub> 100V/div. ∎ ß V<sub>DS</sub> [ 100V/div. V<sub>DS</sub> [ 100V/div. V<sub>HV</sub> 50V/div. V<sub>HV</sub> 50V/div. 400ms/div. 400ms/div. 200ms/div. X-Cap Discharge **Conducted EMI** Conducted EMI 230V<sub>AC</sub>, L Wire 230V<sub>AC</sub>, N Wire 265V<sub>AC</sub>, No Load dBµV dBµV SGL CLRWI CLRWF TDS 2 AV CLRWF 2 AV CLRWF V<sub>IN</sub> 100V/div. 6DB

200ms/div.





HFC0500 Rev. 1.1 5/10/2019

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# TYPICAL PERFORMANCE CHARACTERISIC (continued)

 $V_{IN}$ =230VAC,  $V_{OUT}$ =19V,  $I_{OUT}$ =2.35A,  $T_A$ =25°C, unless otherwise noted.

## **No Load Power Consumption**

V <sub>IN</sub> (VAC/Hz)	85/60	115/60	230/50	265/50
P <sub>IN</sub> (mW)	73.63	67.31	72.37	78.86

#### HFC0500 - FIXED-FREQUENCY FLYBACK CONTROLLER WITH ULTRA-LOW NO LOAD POWER CONSUMPTION

# **OPERATION**

HFC0500 incorporates all the necessary features to build a reliable switch-mode power supply. It is a fixed-frequency current-mode controller with internal slope compensation. At light loads, the controller freezes the peak current and reduces its switching frequency down to 25kHz to minimize switching losses. When the output power falls below a given level, the controller enters burst mode. It also has excellent EMI performance due to frequency jittering.

Its high level of integration requires very few external components.

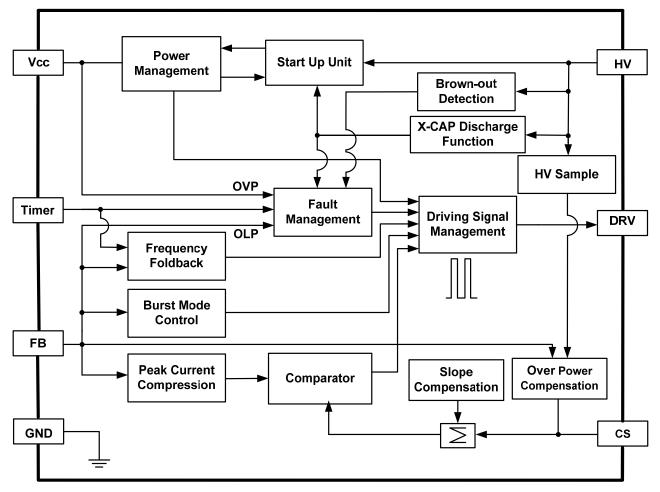
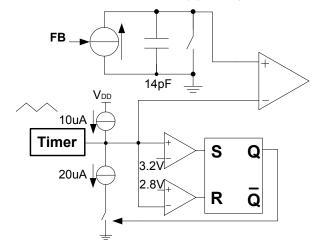


Figure 1: Functional Block Diagram

#### **Fixed-Frequency with Jitter**

Frequency jitter reduces EMI by spreading the energy over the jitter frequency range. Figure 2 shows the circuit of frequency jittering.



**Figure 2: Frequency Jitter Circuit** 

A controlled current sourced (fixed at  $2.72\mu$ A when V<sub>FB</sub>=2V) charges the internal 14pF capacitor. Comparing the capacitor voltage to the TIMER voltage determines the switching frequency as per equation (1). Frequency jitter is accomplished by varing V<sub>TIMER</sub> between 3.2V and 2.8V per equation (2).

$$f_{s} = \frac{1}{14 p F \cdot V_{\text{TIMER}} / 2.72 \mu A + 0.2 \mu s} \qquad (1)$$

$$T_{jitter} = 2 \cdot \frac{C_{TIMER} \cdot (3.2V - 2.8V)}{10 \mu A}$$
(2)

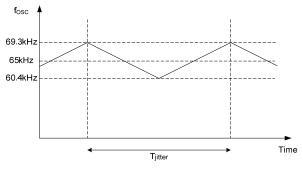


Figure 3: Frequency Jitter

#### **Frequency Foldback**

The HFC0500 implements frequency foldback at light load condition to improve overall efficiency.

When the load decreases to a given level ( $1.0V < V_{FB} < 1.8V$ ), the controller freezes the peak current (as measured on CS, typically 0.7V) while reducing its switching frequency to 25kHz. This reduces the switching loss. If the load continues to decrease, the peak current decreases with 25kHz fixed frequency to avoid audible noise. Figure 4 shows the frequency vs. V<sub>FB</sub> and peak current (V<sub>CS</sub>) vs. V<sub>FB</sub>.

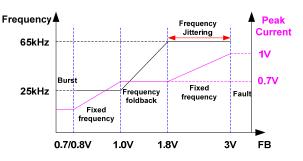


Figure 4: Frequency and Peak Current (V<sub>CS</sub>) vs. V<sub>FB</sub>

# Current-Mode Operation with Slope Compensation

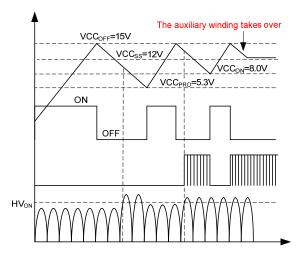
 $V_{FB}$  controls the primary-peak current. When the peak current reaches the level determined by  $V_{FB}$ , DRV turns off. The controller can also be used in continuous conduction mode (CCM) with a wide input voltage range because of its internal slope compensation (25mV/µs, typical), avoiding sub-harmonic oscillations above 50% duty cycle.

# High Voltage Startup Current Source with Brown-Out Detection

At start up, the internal high-voltage current source from HV supplies the IC. The IC turns off the current source as soon as  $V_{CC}$  reaches VCC<sub>OFF</sub> (15V, typical), and detects the voltage on HV. Once the HV voltage exceeds HV<sub>ON</sub> before  $V_{CC}$  drops down to VCC<sub>SS</sub> (12V, typical), the controller starts switching. Otherwise the system treats the condition as a brown-out and

#### EXAMPLE REPORT OF THE ACT OF THE ACK CONTROLLER WITH ULTRA-LOW NO LOAD POWER CONSUMPTION

latches DRV low. When  $V_{CC}$  drops to VCC<sub>PRO</sub> (5.3V, typical), the high-voltage current source turns on to recharge  $V_{CC}$ . The auxiliary transformer winding supplies the IC after the controller starts switching. If  $V_{CC}$  falls below VCC<sub>ON</sub> (8.0V, typical), the switching pulse stops and the current source turns on again. Figure 5 shows the typical  $V_{CC}$  under-voltage lockout waveform.



#### Figure 5: Vcc Under-Voltage Lockout

The  $V_{CC}$  lower threshold UVLO drops from 8V to 5.3V under fault conditions, such as OLP, SCP, brown-out, and OTP.

#### Soft Start

Soft start is externally programmable with a capacitor on TIMER. As this capacitor charges from 1V to 1.75V with 1/4 the normal charge current, the peak current limit threshold gradually increases from 0.25V to 1V while gradually increasing the switching frequency. Figure 6 shows the typical soft-start waveform. The TIMER capacitor determines the start-up duration as follow equation (3).

$$T_{\text{Soft-start}} = \frac{C_{\text{TIMER}} \cdot (1.75V - 1V)}{10/4\mu A}$$
(3)

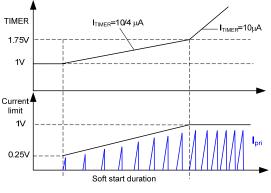


Figure 6: Soft-Start

#### **Burst Mode**

To minimize power dissipation in no load or light load, HFC0500 employs burst-mode operation. As the load decreases, V<sub>FB</sub> decreases. The IC will enter burst-mode when V<sub>FB</sub> drops below the lower threshold V<sub>BURL</sub>(0.7V, typical), stopping output switching. At this point, the output voltage starts to drop, which causes V<sub>FB</sub> to increase again. Once V<sub>FB</sub> exceeds V<sub>BURH</sub>(0.8V, typical), switching resumes. Burst mode alternately enables and disables MOSFET switching, thereby reducing no load or light load switching losses.

#### Adjustable Over Power Compensation

An offset current which is proportional to the input voltage is added to current sense voltage. By choosing the value of the resistor in series with the CS, the amount of compensation can be adjusted to the application for more accurate output power limit at total input range. Figure 7 and Figure 8 show the compensation current relation to FB and peak voltage on HV respectively.

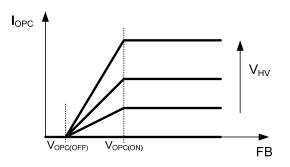


Figure 7: Compensation Current vs. FB and HV Voltage

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FILE FILE FREQUENCY FLYBACK CONTROLLER WITH ULTRA-LOW NO LOAD POWER CONSUMPTION

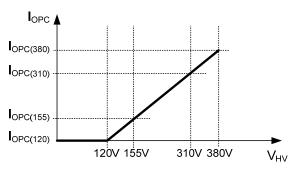
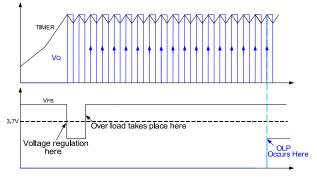


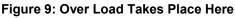
Figure 8: Compensation Current vs. Peak of Rectified Input Line AC Voltage

## **Timer-Based Over-Load Protection**

In a flyback converter, if the switching frequency is fixed, maximum output power is limited by the peak current. The output voltage drops below the set value when the output power exceeds the power limit. This reduces the current through the opto-coupler, pulling  $V_{FB}$  high.

When FB is higher than  $V_{OLP}$  (3.7V, typical) which is considered as an error flag, the timer begins to count. If the error flag is removed during the count, the timer resets. If the timer count reaches 17, OLP triggers. This timer duration avoids triggering OLP during the power supply start-up or short load transients. Figure 9 shows OLP function.





## **Timer-Based Brown-Out Protection**

The brown-out protection block is similar to the OLP block. When the HV voltage drops below  $HV_{OFF}$  (98V, typical) which is considered as an error flag, the timer starts to count. Once the HV voltage is higher than  $HV_{OFF}$ , the timer resets. When the timer counts to 17, brown-out protection triggers and the switching stops.

## **Short-Circuit Protection (SCP)**

The HFC0500 has short-circuit protection if  $V_{CS}$  reaches  $V_{SCP}$  (1.45V, typical) after a reduced leading-edge blanking time ( $T_{LEB2}$ ). As soon as the fault disappears, the power supply resumes operation.

## Thermal Shutdown (TSD)

To prevent any thermal damage, HFC0500 stops switching when the temperature exceeds  $150^{\circ}$ C. As soon as the temperature drops below  $125^{\circ}$ C, the power supply resumes operation. During TSD, the V<sub>CC</sub> UVLO lower threshold drops from 8.0V to 5.3V.

## V<sub>cc</sub> Over-Voltage Protection (OVP)

The HFC0500 enters latched fault condition if  $V_{CC}$  goes above  $V_{OVP}$  (26.5V, typical) for 60µs. The controller stays fully latched until  $V_{CC}$  drops below VCC<sub>LATCH</sub> (2.5V, typical), i.e. when the user unplugs the power supply from the main input and re-plugs it. The situation usually happens when the opto-coupler fails, which results in the loss of output voltage regulation.

## TIMER Latch-Off for OVP and OTP

Pulling TIMER down lower than  $V_{\text{TIMER(LATCH)}}$  (1V, typical) for 12µs can also latch off the IC. This function can be used for external OVP and OTP etc.

## X-Cap Discharge Function

X capacitors are typically positioned across a power supply's input terminals to filter differential mode EMI noise. These components pose a potential hazard because they can store unsafe levels of voltage energy after the AC line is disconnected. Generally, resistors in parallel to the X-cap provide a discharge path to meet safety standards, but these discharge resistors produce a constant loss while the AC is connected, and contribute to no-load and standby input power consumption. "HFC0500 - FIXED-FREQUENCY FLYBACK CONTROLLER WITH ULTRA-LOW NO LOAD POWER CONSUMPTION

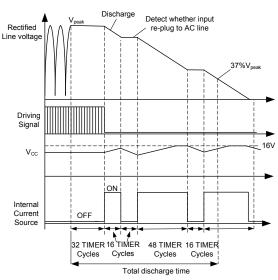


Figure 10: X-Cap Discharger

The HFC0500's HV acts as a smart X-cap discharger. When the AC voltage is applied, the internal high-voltage current source turns off to block HV current and the IC monitors the HV voltage. When removing the AC voltage, the IC turns on the high-voltage current source after about 32 TIMER cycles to discharge the X-cap energy. The first discharge duration is 16 cycles. After the first discharge, the IC turns off the current source for 16 cycles to detect whether the input is re-plugged to the AC line. If the AC input remains disconnected, the IC turns on the current source for 48 cycles to discharge again, and then off for 16 cycles to re-detect repeatedly until the voltage on X-cap drops to V<sub>CC</sub>. Once the reconnected AC input is detected, the highvoltage current source remains off until  $V_{CC}$  drops to VCC<sub>PRO</sub> (5.3V), and then restarts the system by recharging Vcc. Figure 10 shows the discharge function waveforms.

This approach provides an intelligent discharge path for the X-cap, eliminating the power loss form external discharge resistors.

#### **Clamped Driver**

DRV is clamped at  $V_{Clamp}$  (13.4V, typical) when  $V_{CC}$  exceeds 16V, allowing the use of any standard MOSFET.

#### Leading-Edge Blanking

An internal leading-edge blanking (LEB) unit containing two LEB times is employed between the CS and the current comparator input to avoid premature switching pulse termination due to parasitic capacitances. During the blanking time, the current comparator is disabled and can not turn off the external MOSFET. Figure 11 shows the LEB waveform.

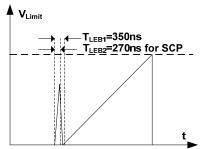


Figure 11: Leading-Edge Blanking

## **APPLICATION INFORMATION**

VCC Capacitor Selection

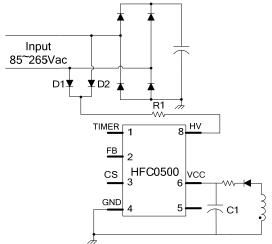


Figure 12: Start-Up Circuit

Figure 12 shows the start-up circuit. The values of R1 and C1 determine the system start-up delay time: a larger R1 or C1 increases the start-up delay. The V<sub>CC</sub> duration (from V<sub>CC,OFF</sub> to V<sub>CC,SS</sub>) for brown-out detection should exceed half of the input period, equation (4) provides an estimated value for the V<sub>CC</sub> capacitor, where I<sub>CC(noswitch)</sub> is the internal consumption (close to I<sub>CClatch</sub>), and T<sub>input</sub> is period of the AC input. For most applications, choose a V<sub>CC</sub> capacitor value that exceeds 10µF.

$$C_{VCC} > \frac{I_{CC(noswitch)} \cdot 0.5 \cdot T_{input}}{VCC_{OFF} - VCC_{SS}}$$
(4)

A higher value R1 decreases the current of internal high-voltage current source especially at low input condition. It is necessary to make sure the practical supply current from HV is not smaller than the corresponding internal IC consumption current which is the same as Icclatch. Thus for universal input range R1 should be smaller than 80k and 20k is generally recommended.

## Primary-Side Inductor Design (L<sub>m</sub>)

With internal slope compensation, HFC0500 supports CCM when the duty cycle exceeds 50%. Set a ratio ( $K_P$ ) of the primary inductor's ripple current amplitude vs. the peak current value to  $0 < K_P \le 1$ , where  $K_P = 1$  for DCM. Figure 13 shows

the relevant waveforms. A larger inductor leads to a smaller  $K_P$ , which can reduce RMS current but increase transformer size. An optimal  $K_P$  value is between 0.6 and 0.8 for the universal input range and 0.8 to 1 for 230VAC input range.

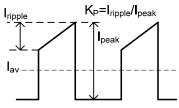


Figure 13: Typical Primary-Current Waveform The input power ( $P_{in}$ ) at the minimum input can be estimated as:

$$\mathsf{P}_{\mathsf{in}} = \frac{\mathsf{V}_{\mathsf{O}} \cdot \mathsf{I}_{\mathsf{O}}}{\eta} \tag{5}$$

Where  $V_0$  is the output voltage,  $I_0$  is the rated output current,  $\eta$  is the estimated efficiency, generally it is between 0.75 and 0.85 depending on the input range and output application.

For CCM at minimum input, the converter duty cycle is:

$$D = \frac{(V_{O} + V_{F}) \cdot N}{(V_{O} + V_{F}) \cdot N + V_{in(min)}}$$
(6)

Where:

V<sub>F</sub> is the secondary diode's forward voltage,

N is the transformer turn ratio, and

 $V_{\text{in(min)}}$  is the minimum voltage on bulk capacitor. The MOSFET turn-on time is:

$$\mathbf{T}_{\rm on} = \mathbf{D} \cdot \mathbf{T}_{\rm s} \tag{7}$$

Where  $T_s$  is the frequency jitter's dominant switching period,  $\frac{1}{T_s}=f_s=65 kHz$  .

The average, peak, ripple and valley values of the primary current are described as follows:

$$I_{av} = \frac{P_{in}}{V_{in(min)}}$$
(8)

$$I_{\text{peak}} = \frac{I_{\text{av}}}{(1 - \frac{K_{\text{P}}}{2}) \cdot D}$$
(9)

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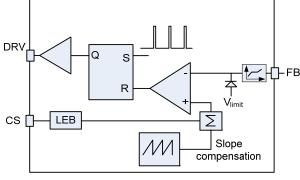
$$\mathbf{I}_{\mathsf{ripple}} = \mathbf{K}_{\mathsf{P}} \cdot \mathbf{I}_{\mathsf{peak}} \tag{10}$$

$$\mathbf{I}_{\text{valley}} = (1 - \mathbf{K}_{\text{P}}) \cdot \mathbf{I}_{\text{peak}}$$
(11)

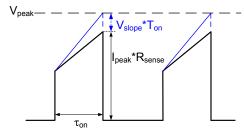
The following equation estimates L<sub>m</sub> as:

$$L_{m} = \frac{V_{in(min)} \cdot T_{on}}{I_{ripples}}$$
(12)

#### **Current-Sense Resistor**



a) Peak-Current-Comparator Circuit



b) Typical Waveform

#### Figure 14: Peak-Current Comparator

Figure 14 shows the peak-current-comparator logic and the subsequent waveform. When the sum of the sensing resistor voltage and the slope compensator reaches  $V_{peak}$ , the comparator goes HIGH to reset the RS flip-flop, and the DRV is pulled down to turn off the MOSFET. The maximum current limit ( $V_{limit}$ , as measured by  $V_{CS}$ ) is 0.95V. The slope compensator ( $V_{slope}$ ) is ~25mV/µs. Given a certain margin, use 0.95× $V_{limit}$  as  $V_{peak}$  at full load. Then the voltage on sensing resistor can be obtained:

$$V_{\text{sense}} = 95\% \cdot V_{\text{limit}} - V_{\text{slope}} \cdot T_{\text{on}} \tag{13}$$

So the value of the sense resistor is:

$$\mathsf{R}_{\mathsf{sense}} = \frac{\mathsf{V}_{\mathsf{sense}}}{\mathsf{I}_{\mathsf{peak}}} \tag{14}$$

Select the current sense resistor with an appropriate power rating. The following equation gives the sense resistor power loss:

$$\mathsf{P}_{\mathsf{sense}} = \left[ \left( \frac{\mathsf{I}_{\mathsf{peak}} + \mathsf{I}_{\mathsf{valley}}}{2} \right)^2 + \frac{1}{12} \left( \mathsf{I}_{\mathsf{peak}} - \mathsf{I}_{\mathsf{valley}} \right)^2 \right] \cdot \mathsf{D} \cdot \mathsf{R}_{\mathsf{sense}}$$
(15)

Low-Pass Filter on CS

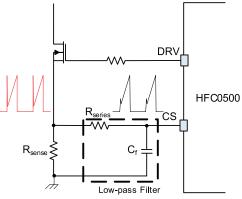


Figure 15: Low-Pass Filter on CS

A small capacitor connected to the CS with  $R_{series}$  forms a low-pass filter for noise filtering when the MOSFET turns on and off, as showed in Figure 15. The low-pass filter's R×C constant should not exceed 1/3 of the leading-edge blanking period for SCP (T<sub>LEB2</sub>, 270ns, typical), otherwise the filtered sensed voltage cannot reach the SCP point (1.45V) to trigger SCP if an output short circuit occurs.

#### **Over Power Compensation**

HFC0500 has the over power compensation function (OPC) by drawing current from CS. The purpose of OPC is to minimize OLP difference caused by different input voltage. The offset current is proportional to the input peak voltage sensed by HV.

Suppose the resistor in current sensing loop is  $R_{series}$ , and the input voltage 220Vac, then the compensation voltage on the CS can be calculated as:

$$V_{\text{comp}} = \mathbf{R}_{\text{series}} \cdot \mathbf{I}_{\text{opc}_{310V}}$$
(16)

The compensation criteria is making the FB voltage under full load condition is similar whether in high line or low line.

#### **Jitter Period**

Frequency jitter is an effective method to reduce EMI by dissipating energy. The n<sub>th</sub>-order harmonic noise bandwidth is  $B_{Tn} = n \cdot (2 \cdot \Delta f + f_{jitter})$ , where  $\Delta f$  is the frequency jitter amplitude. If  $B_{Tn}$  exceeds the resolution bandwidth (RBW) of the spectrum analyzer (200Hz for noise frequency less than 150 kHz, 9 kHz for noise frequency between 150 kHz to 30MHz), the spectrum analyzer receives less noise energy.

The capacitor on the TIMER determines the period of the frequency jitter. A  $10\mu$ A current source charges the capacitor; when the TIMER voltage reaches 3.2V, another  $10\mu$ A current source discharges the capacitor to 2.8V. This charging and discharging cycle repeats.

Equation (2) describes the jitter period in theory; a smaller f<sub>iitter</sub> is more effective at EMI reduction. However, the measurement bandwidth requires that fitter should be large compared to spectrum analyzer RBW for effective EMI reduction. Also, fijtter should be less than the control-loop-gain crossover frequency to avoid disturbing the output voltage regulation. At the same time, we must consider the practical application when selected the Timer capacitor. Too large capacitor may cause failing startup at full load because of the long soft startup duration showed as equation (3). At the same time too small timer capacitor will cause timer period get smaller, so the timer count capability is overload, and some logic problem may be occurs. So for most applications, f<sub>iitter</sub> between 200Hz and 400Hz is recommended.

## X-Cap Discharge Time

Figure 10 shows the X-cap discharger waveforms. The maximum discharge time occurs at a high-line input with no-load condition.

The maximum discharge delay time is

$$T_{delay} = 32 \cdot T_{jitter}$$
(17)

The Xcap is discharged from a high-voltage constant current source ( $I_{HV_120V}$ , 2.5mA typically) into HV. The current-source discharge time for

the X-cap to drop to 37% of peak voltage can be estimated by:

$$T_{discharge} = \frac{C_{X} \cdot 63\% \cdot \sqrt{2} \cdot V_{ac(max)}}{I_{HV\_120V}}$$
(18)

Where  $C_X$  is the X-cap capacitance,  $V_{ac(max)}$  is the maximum AC-input RMS value.

The first discharging period is  $16 \times T_{jitter}$ , with subsequent period equal to  $48 \times T_{jitter}$ . Then the discharge sections times can approximately as:

$$n = \frac{T_{discharge} - 16 \cdot T_{jitter}}{48 \cdot T_{jitter}} + 1$$
(19)

For every discharge section, there is a certain period (16×Tjitter) for detection as follow:

$$\Gamma_{\text{detect}} = 16 \cdot T_{\text{jitter}} \cdot (n-1)$$
 (20)

As a result, the total discharge time is then:

$$T_{total} = T_{delay} + T_{discharge} + T_{detect}$$
(21)

The total discharge time is relative to  $T_{jitter}$  which is dependent on  $C_{\text{TIMER}}$ . For example, if  $C_{\text{TIMER}}$  is 47nF and  $T_{jitter}$ =3.7ms, the X-cap discharge margin is 1s due to X-cap value tolerance ( $\pm 10\%$  typically). It is recommended to select an X-cap less than 3.3 $\mu$ F.

Though the X-cap has been discharged, it may still retain a high-voltage on the bulk capacitor. For safety, make sure it is released before debugging the board.

#### Ramp Compensation

When adopting peak current control, sub harmonic oscillation will occur when D>0.5 in CCM. HFC0500 is equipped with internal ramp compensation to solve this problem.  $\alpha$  is calculated by the following equation (22). For stable operation,  $\alpha$  must be less than 1.

$$\alpha = \frac{\frac{D_{max} \cdot V_{in(min)}}{(1 - D_{max}) \cdot L_m} \cdot R_{sense} - m_a}{\frac{V_{in(min)}}{L_m} \cdot R_{sense} + m_a}$$
(22)

Where m<sub>a</sub>=18mV/us, is the minimum internal slope value of the compensation ramp,  $\frac{V_{in(min)}}{L_m} \cdot R_{sense}$  and  $\frac{D_{max} \cdot V_{in(min)}}{(1-D_{max}) \cdot L_m} \cdot R_{sense}$  is slew rate

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of the primary-side and equivalent secondaryside voltage sensed by CS resistor respectively.

#### PCB Layout Guide

PCB layout is very important to achieve reliable operation, good EMI performance and good thermal performance. Follow these guidelines to optimize performance:

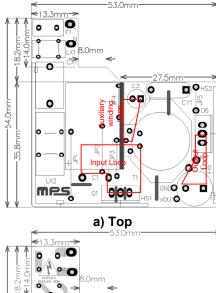
- 1) Minimize the power stage loop area. This includes the input loop (C1 T1 Q1 R11/R12/R13 C1), the auxiliary winding loop (T1 D4 R4 C3 T1), and the output loop (T1 D6 C10 T1).
- 2) The input loop GND and control circuit should be separate and only connect at C1.
- 3) Connecting the Q1 heat-sink to the primary GND plane to improve EMI.
- Place the control circuit capacitors (such as those for FB, CS and VCC) close to IC to decouple noise.

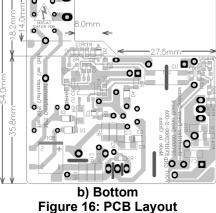


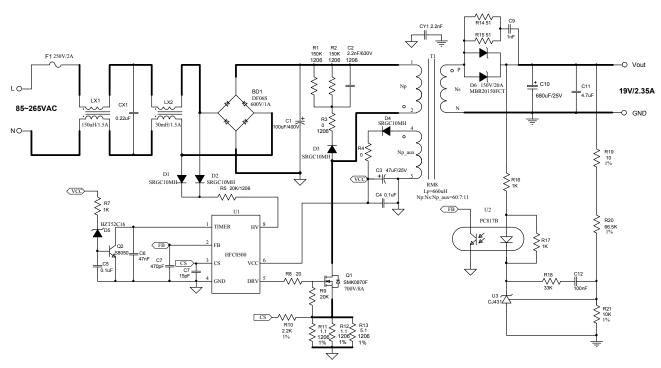
Below is a design example of HFC0500 for power adapter applications.

Table 1: Design Spec.

V <sub>IN</sub>	85 to 265VAC	
Vout	19V	
Ιουτ	2.35A	

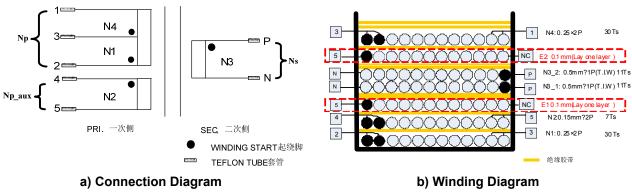






# TYPICAL APPLICATION CIRCUIT

Figure 17: Example of a Typical Application



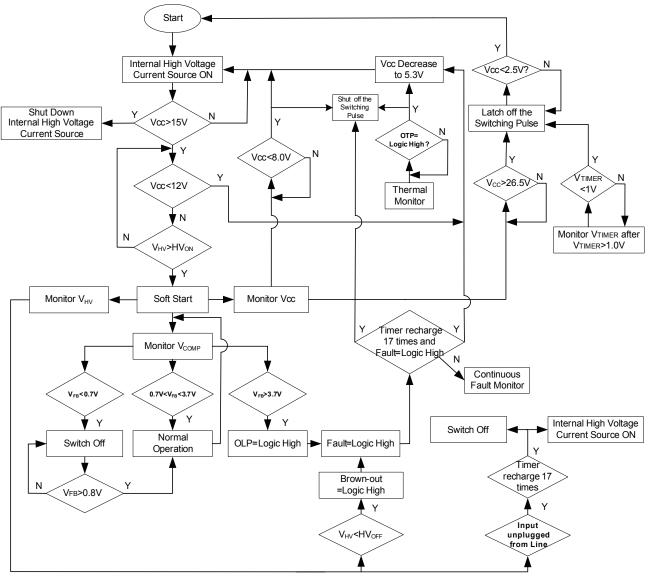


			-		
Tape (T)	Winding	Terminal Start—>End	Wire Size (φ)	Turns(T)	Tube
	N1	2—>3	0.25mm*2	30	matching with wire
	N2	4—>5	0.15mm*2	7	matching with wire
1	E1	5—>Nc	0.1mm*12	Wind with tight tension across entire bobbin evenly	
	N3	P>N	0.5mm*2(T.I,W)	11	
2	E2	5—>NC	0.1mm*2	Wind with tight tension across entire bobbin evenly	
1	N4	3—>1	0.25mm*2	30	matching with wire

Table 2: Winding Order

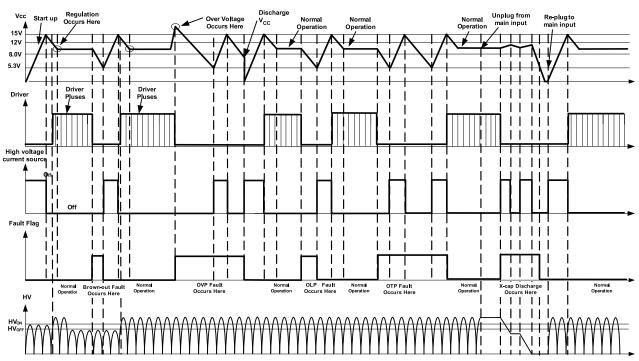
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# **FLOW CHART**



UVLO, brown-out, OTP & OLP is auto restart, OVP on VCC and Latch-off on TIMER are latch mode Release from the latch condition , need to unplug from the main input .

## Figure19: Control Flow Chart

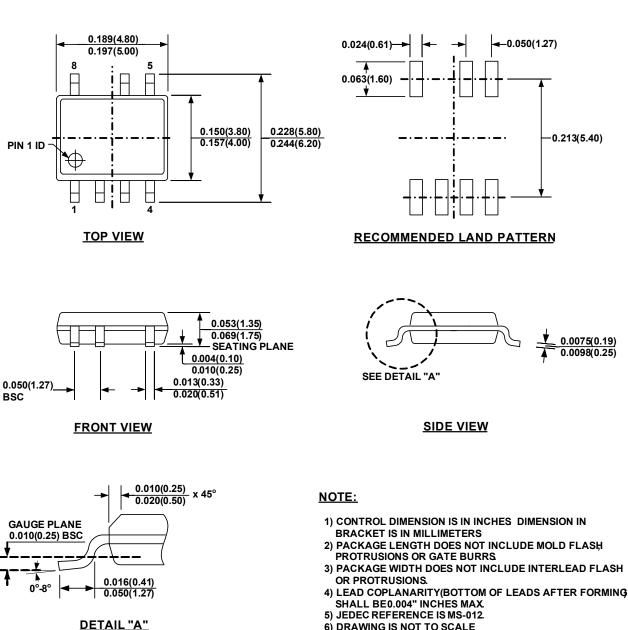


# **EVOLUTION OF THE SIGNALS IN PRESENCE OF FAULTS**

Figure 20: Signal Evolution in the Presence of Faults

SOIC8-7A

# **PACKAGE INFORMATION**



6) DRAWING IS NOT TO SCALE

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